



**SPECIFICATION
FOR
LCD Module
KD024C-1A**

MODULE:	KD024C-1A
CUSTOMER:	

REV	DESCRIPTION	DATE
1.0	FIRST ISSUE	2015.01.27

STARTEK	INITIAL	DATE
PREPARED BY		
CHECKED BY		
APPROVED BY		

CUSTOMER	INITIAL	DATE
APPROVED BY		



Revision History

[illegible]

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General Description

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* Description

This is a color active matrix TFT (Thin Film Transistor) LCD (liquid crystal display) that uses amorphous silicon TFT as a switching device. This model is composed of a Transmissive type TFT-LCD Panel, driver circuit, back-light unit. The resolution of a 2.4'TFT-LCD contains 240x320 pixels, and can display up to 65K colors.

* Features

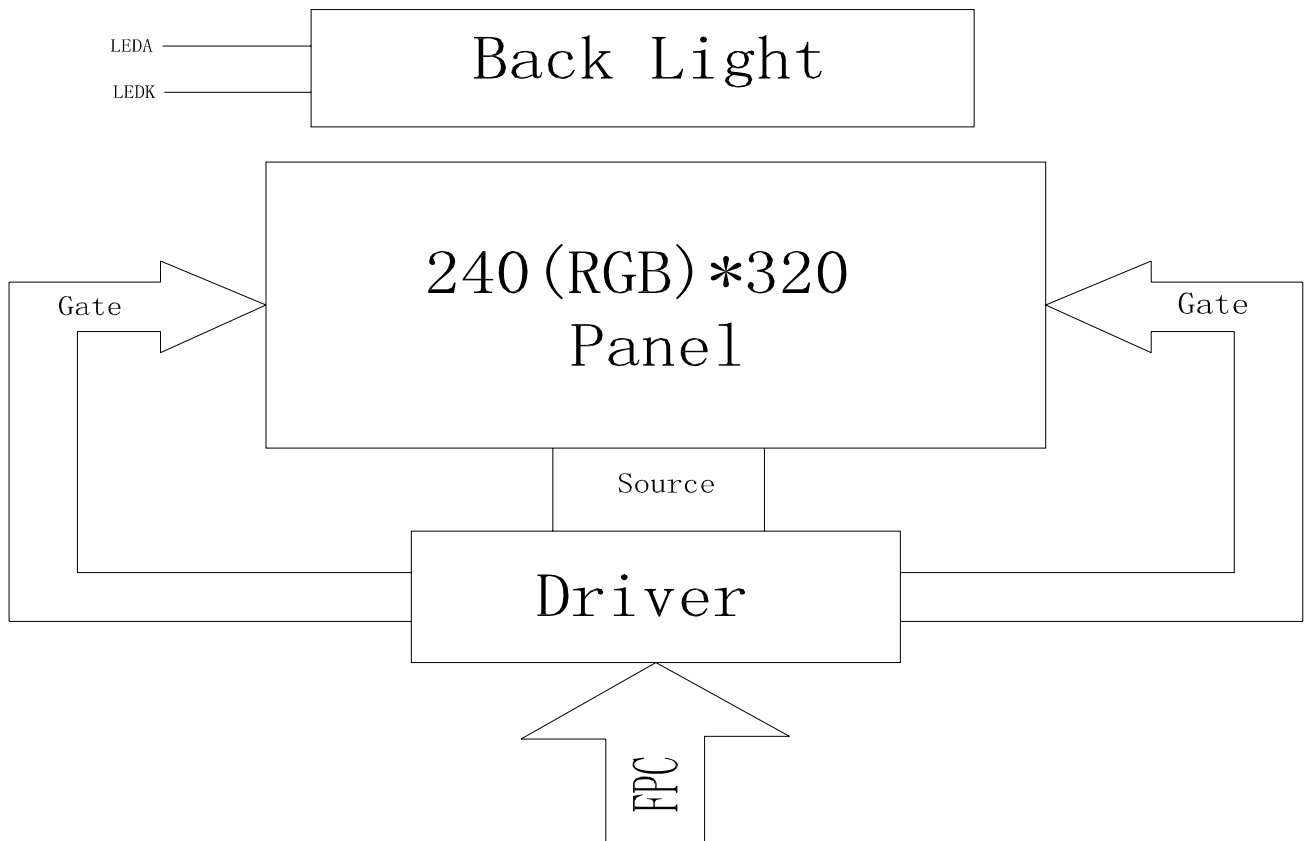
- Low Input Voltage: 3.3V(TYP)
- Display Colors of TFT LCD: 65Kcolors
- RGB Interface: 8/16/18Bit

General Information Items	Specification	Unit	Note
	Main Panel		
Display area(AA)	36.72(H)*48.96(V) (2.4inch)	mm	-
Driver element	TFT active matrix	-	-
Display colors	65K	colors	-
Number of pixels	240(RGB)*320	dots	-
Pixel arrangement	RGB vertical stripe	-	-
Pixel pitch	0.153(H)*0.153(V)	mm	-
Viewing angle	12:00	o'clock	-
Controller IC	ST7789V	-	-
Display mode	Transmissive/ Normally White	-	-
Operating temperature	-20~+70	℃	-
Storage temperature	-30~+80	℃	-

* Mechanical Information

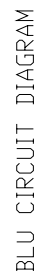
Item		Min.	Typ.	Max.	Unit	Note
Module size	Horizontal(H)		42.72		mm	-
	Vertical(V)		60.26		mm	-
	Depth(D)		2.6		mm	-
Weight			TBD		g	-

1. Block Diagram



2. Outline dimension

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NOTES:

1. DISPLAY TYPE: 2.4", TFT-LCD, 65K COLORS
2. DISPLAY MODE: T/N NORMALLY WHITE
3. VIEWING DIRECTION: 12:00
4. DRIVER IC: S17789V (COG)
5. VCI: 3.3V, IOVCC:1.8~3.3V
6. OPERATING TEMP: -20°C TO 70°C
STORAGE TEMP: -30°C TO 80°C
7. BACK LIGHT: LED WHITE, 4 LED, 60mA, 3.2±0.1V
8. RoHS COMPLIANT.

PIN	DESCRIPTION
1	DB0
2	DB1
3	DB2
4	DB3
5	GN01
6	IDVCC
7	/CS
8	RS
9	/WR
10	/RD
11	IM0
12	XL
13	Y0
14	XR
15	YD
16	LED-A
17	LED-K1
18	LED-K2
19	LED-K3
20	LED-K4
21	NC
22	DB4
23	DB0
24	DB11
25	DB12
26	DB13
27	DB14
28	DB15
29	DB16
30	DB17
31	/RESET
32	VCI
33	IDVCC
34	GND
35	DB5
36	DB6
37	DB7

IM0	Interface type	D8 Pin in use
0	i80-system 16-bit interface	D17-D10, D8-D1
1	i80-system 8-bit interface	D17-D10

NOTE: If not use PIN, fix to the GND.

TOLERANCE (公差) TOLERANCE UNLESS OTHERWISE SPECIFIED X.X±0.3 X.XX±0.2	DRAWING NAME	KD024C-1A-LCM
	PARTS NO.	
	Drawn Checked Unit mm	
Scale 1:1 	Approve	Page 1/1

Rev	Revision content description	Date
A	FIRST	2014/01/06
B	更改驱动IC为77S9V	2014/01/16

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3. Input terminal Pin Assignment

1	DB0	H/L	DATA BUS. If not used pins must be fixed to GND level.
2	DB1	H/L	
3	DB2	H/L	
4	DB3	H/L	
5	GND	L	GND
6	IOVCC	H	POWER SUPPLY
7	/CS	H/L	Chip select input pin
8	RS	H/L	A register select signal
9	/WR	H/L	Write enable clock input pin
10	/RD	H/L	Read enable clock input pin
11	IM0	H/L	Interface select.
12	X+		NO CONNECT
13	Y+		NO CONNECT
14	X-		NO CONNECT
15	Y-		NO CONNECT
16	LED-A	H	Backlight+
17	LED-K1	L	Backlight-
18	LED-K2	L	Backlight-
19	LED-K3	L	Backlight-
20	LED-K4	L	Backlight-
21	NC	H/L	NC
22	DB4	H/L	DATA BUS If not used pins must be fixed to GND level.
23	DB10	H/L	
24	DB11	H/L	
25	DB12	H/L	
26	DB13	H/L	
27	DB14	H/L	
28	DB15	H/L	
29	DB16	H/L	
30	DB17	H/L	
31	/RESET	H/L	HARDWARE RESET PIN
32	VCI	H	POWER SUPPLY
33	IOVCC	H	POWER SUPPLY
34	GND	L	GND
35	DB5	H/L	DATA BUS DB5 If not used pins must be fixed to GND level.
36	DB6	H/L	
37	DB7	H/L	

4. LCD Optical Characteristics

4.1 Optical specification

Item		Symbol	Conditions	Specifications			Unit	Note
				Min.	Typ.	Max.		
Transmittance		T%	Viewing normal angle $\theta_X = \theta_Y = 0^\circ$	4.5	5.0	-	%	All left side data are based on CMI's following condition – 1.LC : TN 2.Light Source :CMI LED BLU 3.Film : 日東 NPF TEG 1465DU 4.Machine : DMS 803
Contrast Ratio		CR		-	500	-		
Response Time (by Quick)		T _{on} + T _{off}		-	30	-	ms	
Viewing Angle	Hor.	θ_{X+}	Center CR>10	-	45	-	deg.	
		θ_{X-}		-	45	-		
	Ver.	θ_{Y+}		-	45	-		
		θ_{Y-}		-	20	-		
CF only Color Chromaticity (CIE 1931)	Red	X _R	Viewing normal angle $\theta_X = \theta_Y = 0^\circ$	0.592	0.612	0.632		1.Under C light Simulation 2.NTSC 56%
		Y _R		0.309	0.329	0.349		
	Green	X _G		0.279	0.299	0.319		
		Y _G		0.547	0.567	0.587		
	Blue	X _B		0.124	0.144	0.164		
		Y _B		0.090	0.110	0.130		
	White	X _W		0.288	0.308	0.328		
		Y _W		0.305	0.325	0.345		

*Note (1) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

$$\text{Contrast Ratio (CR)} = L_{63} / L_0$$

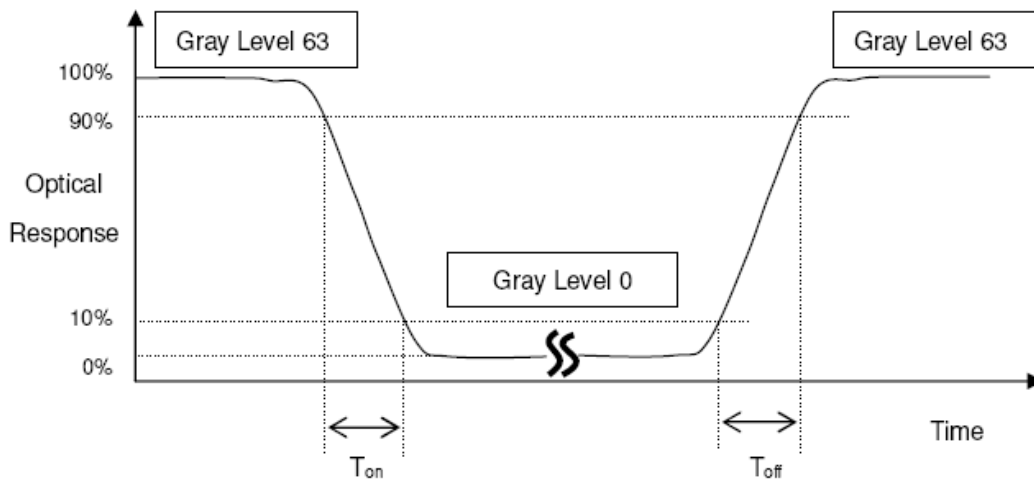
L63: Luminance of gray level 63

L0: Luminance of gray level 0

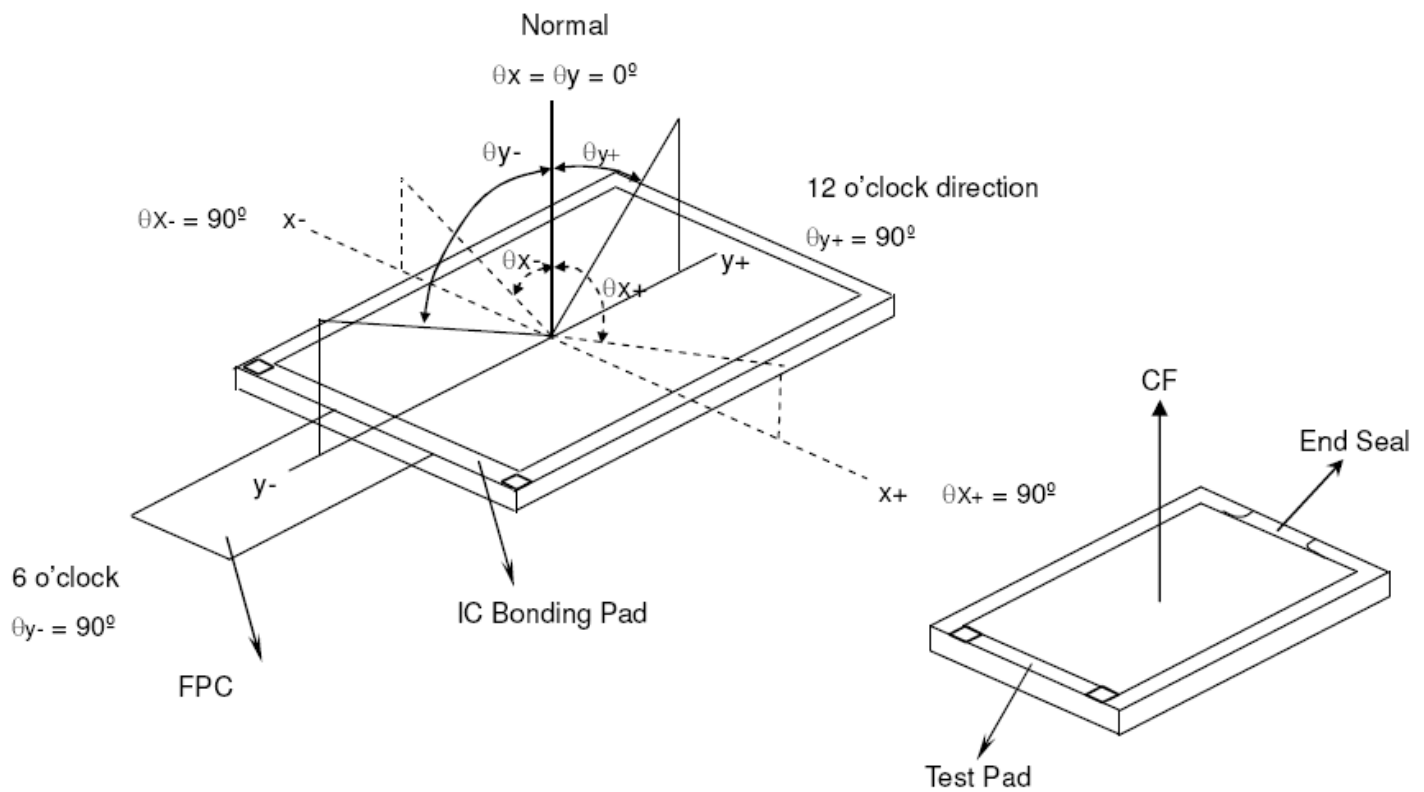
$$CR = CR(5)$$

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (5).

*Note (2) Definition of Response Time (T_{on} , T_{off}):



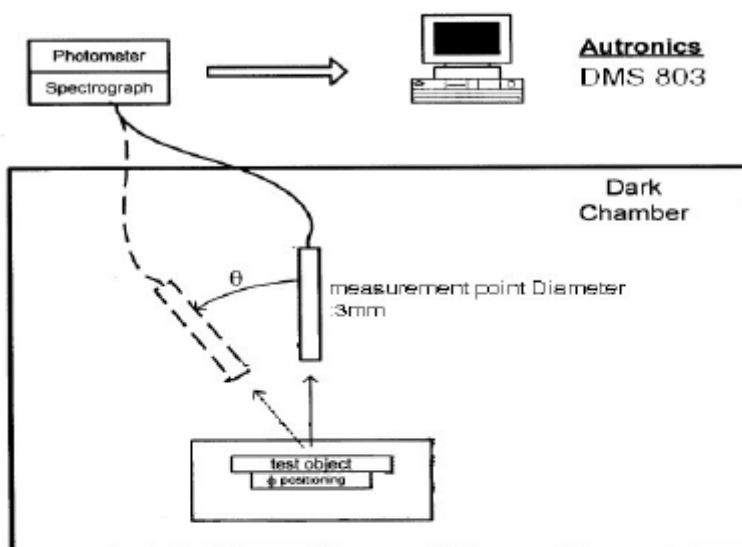
*Note (3) Definition of Viewing Angle



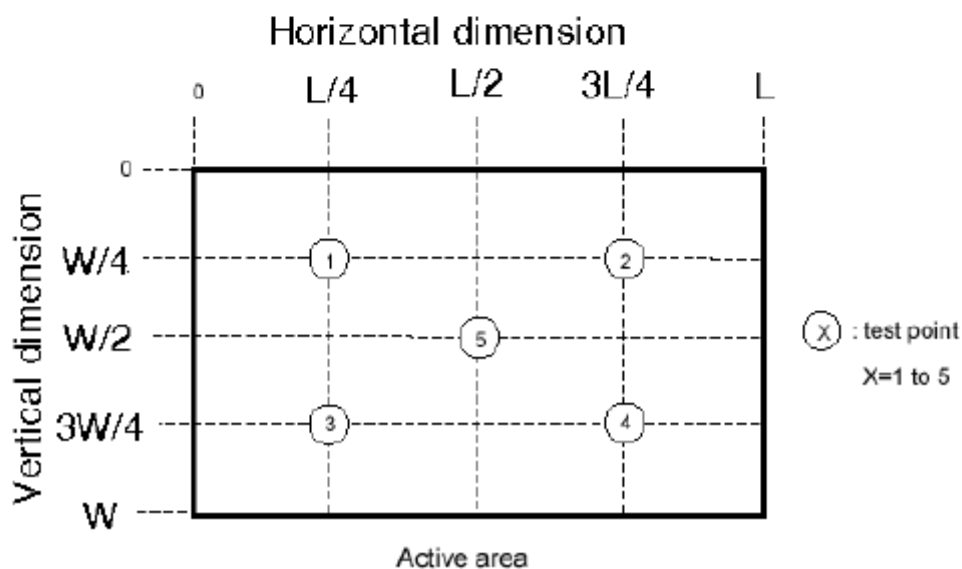


*Note (4) Measurement Set-Up:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.



*Note (5)



5. Electrical Characteristics

5.1 Absolute Maximum Rating (Ta=25 VSS=0V)

Characteristics	Symbol	Min.	Max.	Unit
Digital Supply Voltage	VDD	-0.3	4.6	V
Digital interface supply Voltage	VDDIO	-0.3	4.6	V
Operating temperature	T _{OP}	-20	+70	°C
Storage temperature	T _{ST}	-30	+80	°C

5.2 DC Electrical Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Unit	Note
Digital Supply Voltage	VDD	2.4	3..3	4.2	V	
Digital interface supply Voltage	VDDIO	1.65	3.3	4.2	V	
Normal mode Current consumption	IDD	--	8	--	mA	
Level input voltage	V _{IH}	0.7V _{DDIO}		VDDIO	V	
	V _{IL}	GND		0.3V _{DDIO}	V	
Level output voltage	V _{OH}	0.8VDDIO		VDDIO	V	
	V _{OL}	GND		0.2VDDIO	V	

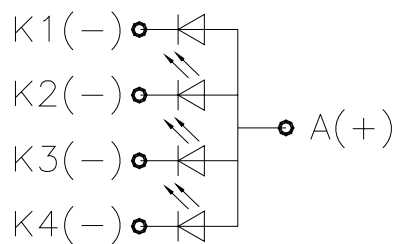
5.3 LED Backlight Characteristics

The back-light system is edge-lighting type with 4chips White LED

Item	Symbol	Min.	Typ.	Max.	Unit	Note
Forward Current	I_F	60	80	--	mA	
Forward Voltage	V_F	--	3.2	--	V	
LCM Luminance	L_v	200	250	--	cd/m ²	
LED life time	Hr	50000	--	--	Hour	Note1,2
Uniformity	AVg	80	--	--	%	

Note (1) LED life time (Hr) can be defined as the time in which it continues to operate under the condition: $T_a=25\pm3\text{ }^{\circ}\text{C}$, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note (2) The “LED life time” is defined as the module brightness decrease to 50% original brightness at $T_a=25^{\circ}\text{C}$ and $I_L=80\text{mA}$. The LED lifetime could be decreased if operating I_L is larger than 80mA. The constant current driving method is suggested.

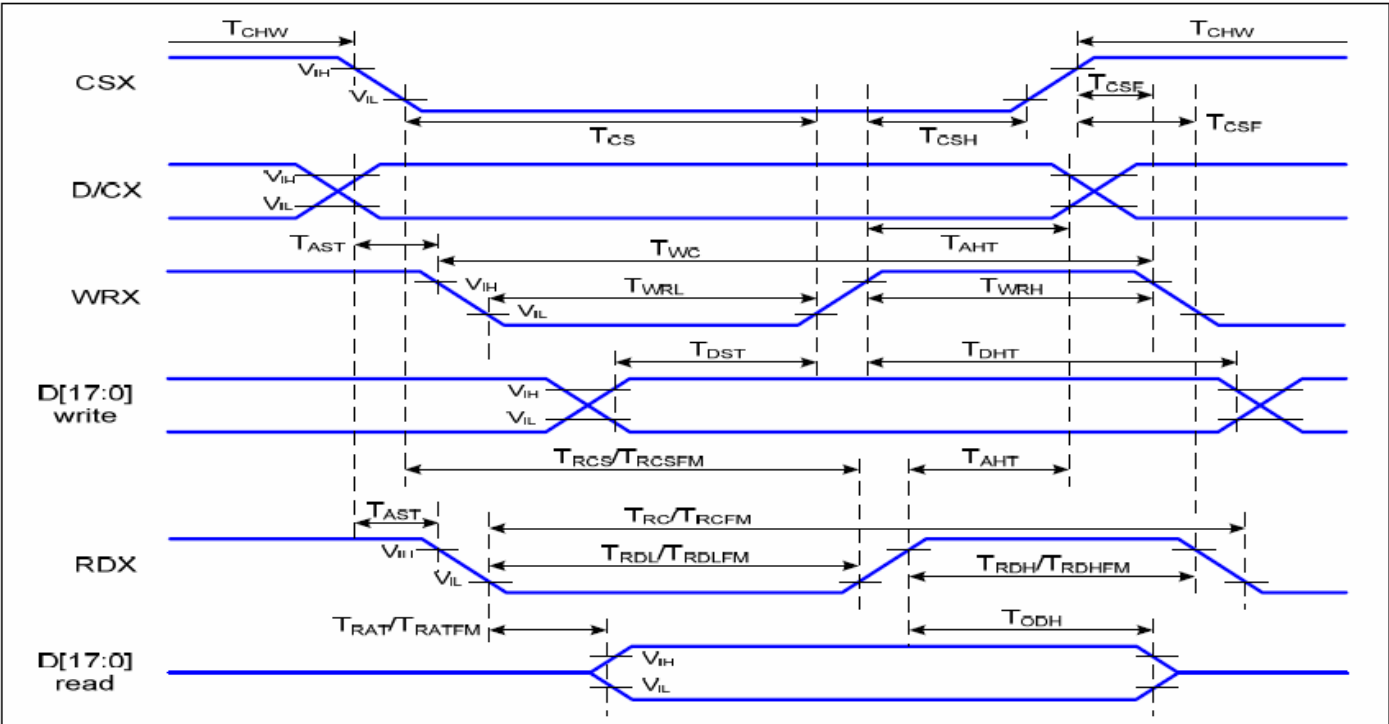


BLU CIRCUIT DIAGRAM

6. AC Characteristic

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6.1. Display Parallel 18/16/9/8-bit Interface Timing Characteristics (8080- system)



VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta= -30 to 70 ℃

Signal	Symbol	Parameter	Min	Max	Unit	Description
D/CX	T _{AST}	Address setup time	0		ns	-
	T _{AHT}	Address hold time (Write/Read)	10		ns	
CSX	T _{CHW}	Chip select "H" pulse width	0		ns	-
	T _{CS}	Chip select setup time (Write)	15		ns	
	T _{RCS}	Chip select setup time (Read ID)	45		ns	
	T _{RCSFM}	Chip select setup time (Read FM)	355		ns	
	T _{CSF}	Chip select wait time (Write/Read)	10		ns	
	T _{CSH}	Chip select hold time	10		ns	
WRX	T _{WC}	Write cycle	66		ns	-
	T _{WRH}	Control pulse "H" duration	15		ns	
	T _{WRL}	Control pulse "L" duration	15		ns	
RDX (ID)	T _{RC}	Read cycle (ID)	160		ns	When read ID data
	T _{RDH}	Control pulse "H" duration (ID)	90		ns	
	T _{RDL}	Control pulse "L" duration (ID)	45		ns	
RDX (FM)	T _{RCFM}	Read cycle (FM)	450		ns	When read from frame memory
	T _{RDHFM}	Control pulse "H" duration (FM)	90		ns	
	T _{RDLFM}	Control pulse "L" duration (FM)	355		ns	
D[17:0]	T _{DST}	Data setup time	10		ns	For CL=30pF



	T_{DHT}	Data hold time	10		ns
	T_{RAT}	Read access time (ID)		40	ns
	T_{RATFM}	Read access time (FM)		340	ns
	T_{ODH}	Output disable time	20	80	ns

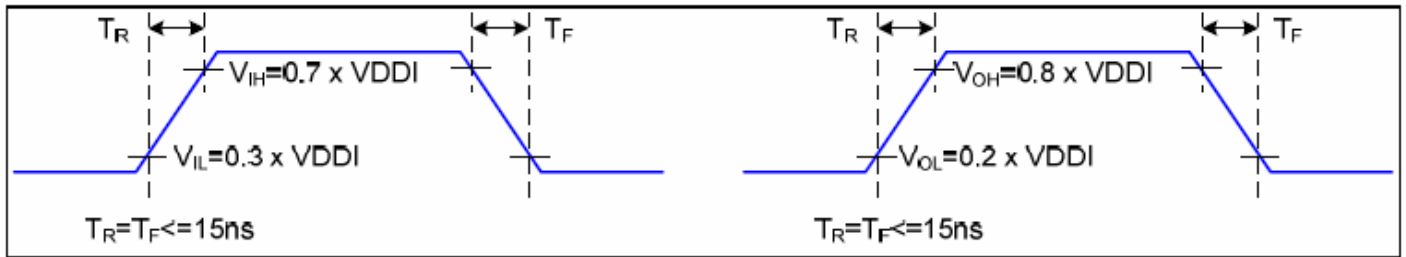


Figure 2 Rising and Falling Timing for I/O Signal

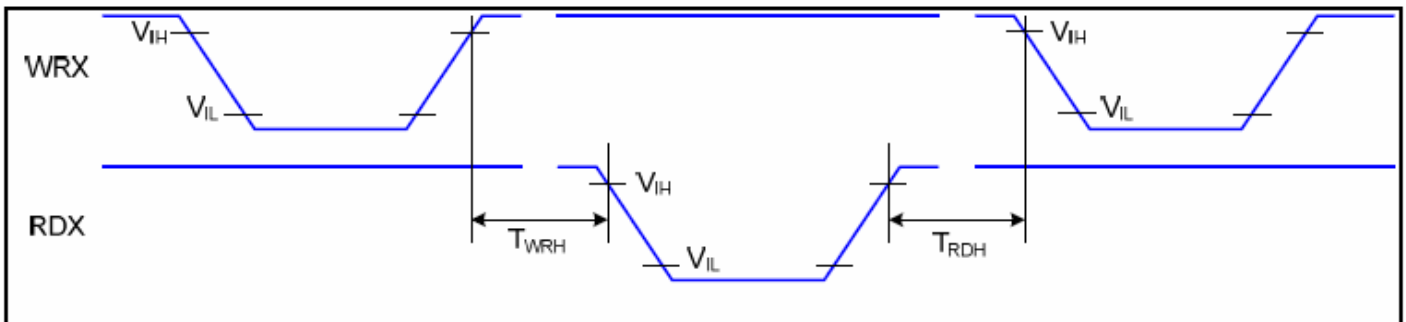


Figure 3 Write-to-Read and Read-to-Write Timing

Note: The rising time and falling time (T_r , T_f) of input signal and fall time are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

6.2 Reset Timing Characteristics

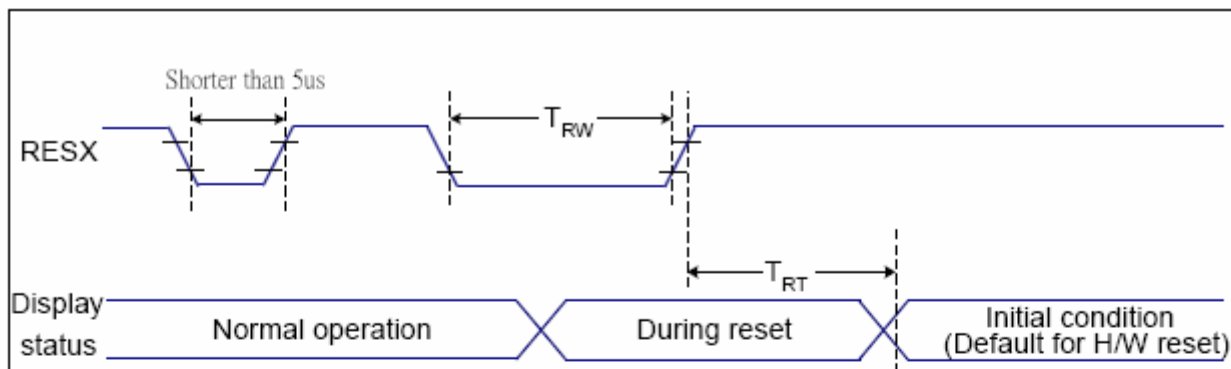


Figure 7 Reset Timing

$V_{DDI}=1.65$ to $3.3V$, $V_{DD}=2.4$ to $3.3V$, $AGND=DGND=0V$, $T_a=-30 \sim 70^\circ C$

Related Pins	Symbol	Parameter	MIN	MAX	Unit
RESX	TRW	Reset pulse duration	10	-	us
	TRT	Reset cancel	-	5 (Note 1, 5)	ms
				120 (Note 1, 6, 7)	ms

Table 8 Reset Timing

Notes:

1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (t_{RT}) within 5 ms after a rising edge of RESX.

2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.

4. Spike Rejection also applies during a valid reset pulse as shown below:

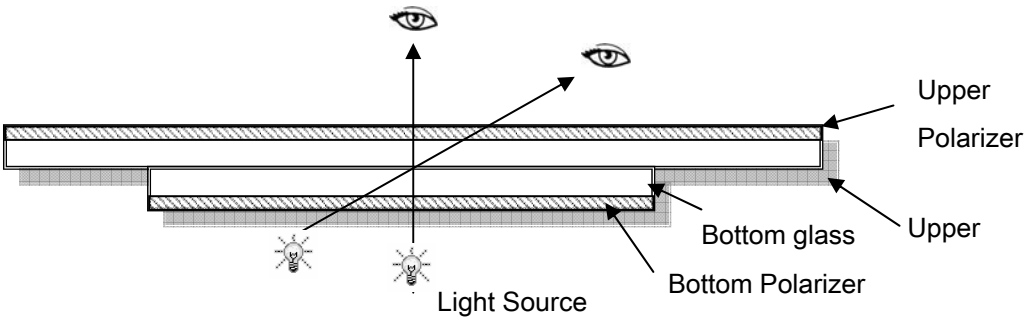
7. LCD Module Out-Going Quality Level

7.1 VISUAL & FUNCTION INSPECTION STANDARD

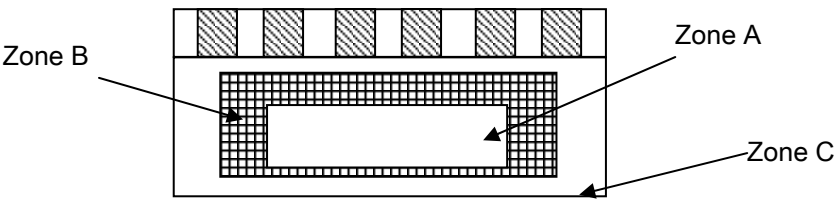
7.1.1 Inspection conditions

Inspection performed under the following conditions is recommended.

- Temperature : 25±5℃
- Humidity : 65%±10%RH
- Viewing Angle : Normal viewing Angle.
- Illumination: Single fluorescent lamp (300 to 700Lux)
- Viewing distance:30–50cm



7.1.2 Definition



- Zone A : Effective Viewing Area(Character or Digit can be seen)
- Zone B : Viewing Area except Zone A
- Zone C : Outside (Zone A+Zone B) which can not be seen after assembly by customer .)

Note:

As a general rule ,visual defects in Zone C can be ignored when it doesn't effect product function or appearance after assembly by customer.

7.1.3 Sampling Plan

According to GB/T 2828-2003 ; , normal inspection, Class II

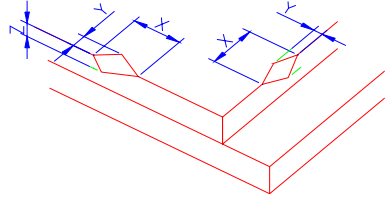
AQL:

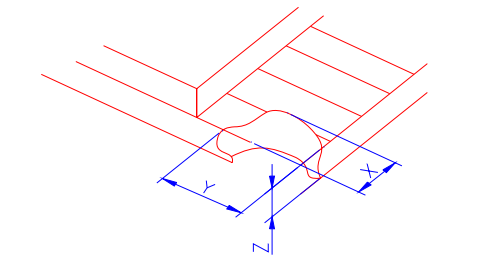
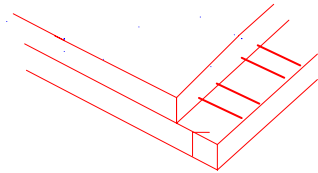
Major defect	Minor defect
0.65	1.5

LCD: Liquid Crystal Display , TP: Touch Panel , LCM: Liquid Crystal Module

No	Items to be inspected	Criteria	Classification of defects
1	Functional defects	1) No display, Open or miss line 2) Display abnormally, Short 3) Backlight no lighting, abnormal lighting. 4) TP no function	Major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	
4	Color tone	Color unevenness, refer to limited sample	Minor
5	Soldering appearance	Good soldering , Peeling off is not allowed.	
6	LCD/Polarizer/TP	Black/White spot/line, scratch, crack, etc.	

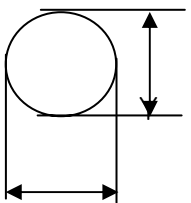
7.1.4 Criteria (Visual)

Number	Items	Criteria(mm)						
1.0 LCD Crack/Broken	(1) The edge of LCD broken	 <table> <tr> <th>X</th><th>Y</th><th>Z</th></tr> <tr> <td>≤3.0mm</td><td><Inner border line of the seal</td><td>≤T</td></tr> </table>	X	Y	Z	≤3.0mm	<Inner border line of the seal	≤T
X	Y	Z						
≤3.0mm	<Inner border line of the seal	≤T						
NOTE: X: Length Y: Width								

Z: Height L: Length of ITO, T: Height of LCD	(2)LCD corner broken	 <table border="1" data-bbox="922 546 1331 647"><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>≤3.0mm</td><td>≤L</td><td>≤T</td></tr></table>	X	Y	Z	≤3.0mm	≤L	≤T
	X	Y	Z					
≤3.0mm	≤L	≤T						
(3) LCD crack	 Crack Not allowed							

2.0

Spot defect



X

$$\Phi = (X+Y)/2$$

① light dot (LCD/TP/Polarizer black/white spot , light dot, pinhole, dent, stain)

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi \leq 0.10$	Ignore		Ignore
$0.10 < \Phi \leq 0.15$	3(distance $\geq 10\text{mm}$)		
$0.15 < \Phi \leq 0.2$	1		
$0.2 < \Phi$	0		

② Dim spot (LCD/TP/Polarizer dim dot, light leakage、dark spot)

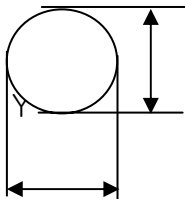
Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi \leq 0.1$	Ignore		Ignore
$0.1 < \Phi \leq 0.2$	2(distance $\geq 10\text{mm}$)		
$0.2 < \Phi \leq 0.3$	1		
$\Phi > 0.3$	0		

③ Polarizer accidented spot

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\phi \leq 0.2$	Ignore		Ignore
$0.2 < \phi \leq 0.5$	2(distance $\geq 10\text{mm}$)		
$\phi > 0.5$	0		

Line defect
(LCD/TP
/Polarizer
black/white
line,
scratch,
stain)

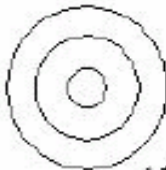
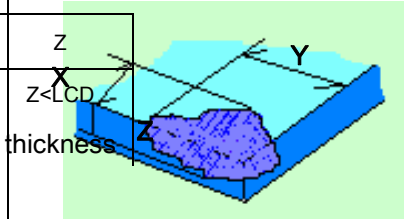
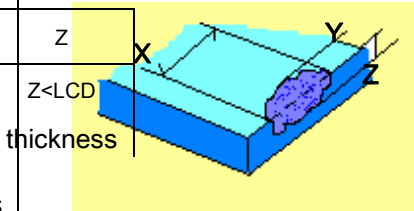
Width(mm)	Length(mm)	Acceptable Qty		
		A	B	C
$\phi \leq 0.03$	Ignore	Ignore		Ignore
$0.03 < W \leq 0.05$	$L \leq 3.0$	$N \leq 2$		
$0.05 < W \leq 0.08$	$L \leq 2.0$	$N \leq 2$		
$0.08 < W$	Define as spot defect			

	Items	Criteria (mm)																																																								
Spot defect  X Y Φ=(X+Y)/2 <td> ① light dot (LCD/TP/Polarizer black/white spot , light dot, pinhole, dent, stain) <table><tr><th rowspan="2">Zone Size (mm)</th><th colspan="3">Acceptable Qty</th></tr><tr><th>A</th><th>B</th><th>C</th></tr><tr><td>Φ≤0.10</td><td colspan="2">Ignore</td><td rowspan="4">Ignore</td></tr><tr><td>0.10<Φ≤0.15</td><td colspan="2">3(distance ≥ 10mm)</td></tr><tr><td>0.15<Φ≤0.2</td><td colspan="2">1</td></tr><tr><td>0.2<Φ</td><td colspan="2">0</td></tr></table> ②Dim spot (LCD/TP/Polarizer dim dot, light leakage、dark spot) <table><tr><th rowspan="2">Zone Size (mm)</th><th colspan="3">Acceptable Qty</th></tr><tr><th>A</th><th>B</th><th>C</th></tr><tr><td>Φ≤0.1</td><td colspan="2">Ignore</td><td rowspan="4">Ignore</td></tr><tr><td>0.1<Φ≤0.2</td><td colspan="2">2(distance ≥ 10mm)</td></tr><tr><td>0.2<Φ≤0.3</td><td colspan="2">1</td></tr><tr><td>Φ > 0.3</td><td colspan="2">0</td></tr></table> ③ Polarizer accidented spot <table><tr><th rowspan="2">Zone Size (mm)</th><th colspan="3">Acceptable Qty</th></tr><tr><th>A</th><th>B</th><th>C</th></tr><tr><td>Φ≤0.2</td><td colspan="2">Ignore</td><td rowspan="3">Ignore</td></tr><tr><td>0.2<Φ≤0.5</td><td colspan="2">2(distance ≥ 10mm)</td></tr><tr><td>Φ>0.5</td><td colspan="2">0</td></tr></table></td>	① light dot (LCD/TP/Polarizer black/white spot , light dot, pinhole, dent, stain) <table><tr><th rowspan="2">Zone Size (mm)</th><th colspan="3">Acceptable Qty</th></tr><tr><th>A</th><th>B</th><th>C</th></tr><tr><td>Φ≤0.10</td><td colspan="2">Ignore</td><td rowspan="4">Ignore</td></tr><tr><td>0.10<Φ≤0.15</td><td colspan="2">3(distance ≥ 10mm)</td></tr><tr><td>0.15<Φ≤0.2</td><td colspan="2">1</td></tr><tr><td>0.2<Φ</td><td colspan="2">0</td></tr></table> ②Dim spot (LCD/TP/Polarizer dim dot, light leakage、dark spot) <table><tr><th rowspan="2">Zone Size (mm)</th><th colspan="3">Acceptable Qty</th></tr><tr><th>A</th><th>B</th><th>C</th></tr><tr><td>Φ≤0.1</td><td colspan="2">Ignore</td><td rowspan="4">Ignore</td></tr><tr><td>0.1<Φ≤0.2</td><td colspan="2">2(distance ≥ 10mm)</td></tr><tr><td>0.2<Φ≤0.3</td><td colspan="2">1</td></tr><tr><td>Φ > 0.3</td><td colspan="2">0</td></tr></table> ③ Polarizer accidented spot <table><tr><th rowspan="2">Zone Size (mm)</th><th colspan="3">Acceptable Qty</th></tr><tr><th>A</th><th>B</th><th>C</th></tr><tr><td>Φ≤0.2</td><td colspan="2">Ignore</td><td rowspan="3">Ignore</td></tr><tr><td>0.2<Φ≤0.5</td><td colspan="2">2(distance ≥ 10mm)</td></tr><tr><td>Φ>0.5</td><td colspan="2">0</td></tr></table>	Zone Size (mm)	Acceptable Qty			A	B	C	Φ≤0.10	Ignore		Ignore	0.10<Φ≤0.15	3(distance ≥ 10mm)		0.15<Φ≤0.2	1		0.2<Φ	0		Zone Size (mm)	Acceptable Qty			A	B	C	Φ≤0.1	Ignore		Ignore	0.1<Φ≤0.2	2(distance ≥ 10mm)		0.2<Φ≤0.3	1		Φ > 0.3	0		Zone Size (mm)	Acceptable Qty			A	B	C	Φ≤0.2	Ignore		Ignore	0.2<Φ≤0.5	2(distance ≥ 10mm)		Φ>0.5	0	
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	Line defect (LCD/TP /Polarizer black/white line, scratch, stain)	<table><tr><th rowspan="2">Width(mm)</th><th rowspan="2">Length(mm)</th><th colspan="3">Acceptable Qty</th></tr><tr><th>A</th><th>B</th><th>C</th></tr><tr><td>$\Phi \leq 0.03$</td><td>Ignore</td><td colspan="2">Ignore</td><td rowspan="3">Ignore</td></tr><tr><td>$0.03 < W \leq 0.05$</td><td>$L \leq 3.0$</td><td colspan="2">$N \leq 2$</td></tr><tr><td>$0.05 < W \leq 0.08$</td><td>$L \leq 2.0$</td><td colspan="2">$N \leq 2$</td></tr><tr><td>$0.08 < W$</td><td colspan="4">Define as spot defect</td></tr></table>					Width(mm)	Length(mm)	Acceptable Qty			A	B	C	$\Phi \leq 0.03$	Ignore	Ignore		Ignore	$0.03 < W \leq 0.05$	$L \leq 3.0$	$N \leq 2$		$0.05 < W \leq 0.08$	$L \leq 2.0$	$N \leq 2$		$0.08 < W$	Define as spot defect			
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	Polarizer Bubble	<table><tr><th rowspan="2">Zone Size (mm)</th><th colspan="3">Acceptable Qty</th></tr><tr><th>A</th><th>B</th><th>C</th></tr><tr><td>$\Phi \leq 0.2$</td><td colspan="2">Ignore</td><td rowspan="4">Ignore</td></tr><tr><td>$0.2 < \Phi \leq 0.4$</td><td colspan="2">2(distance $\geq 10\text{mm}$)</td></tr><tr><td>$0.4 < \Phi \leq 0.6$</td><td colspan="2">1</td></tr><tr><td>$0.6 < \Phi$</td><td colspan="2">0</td></tr></table>					Zone Size (mm)	Acceptable Qty			A	B	C	$\Phi \leq 0.2$	Ignore		Ignore	$0.2 < \Phi \leq 0.4$	2(distance $\geq 10\text{mm}$)		$0.4 < \Phi \leq 0.6$	1		$0.6 < \Phi$	0							
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	SMT	According to IPC-A-610C class II standard . Function defect and missing part are major defect ,the others are minor defect.																														

		TP bubble/ accidented spot	<table><tr><th rowspan="2">Size Φ(mm)</th><th colspan="3">Acceptable Qty</th></tr><tr><th>A</th><th>B</th><th>C</th></tr><tr><td>$\Phi \leq 0.1$</td><td colspan="2">Ignore</td><td rowspan="4">Ignore</td></tr><tr><td>$0.1 < \Phi \leq 0.2$</td><td colspan="2">2</td></tr><tr><td>$0.2 < \Phi \leq 0.3$</td><td colspan="2">1</td></tr><tr><td>$0.3 < \Phi$</td><td colspan="2">0</td></tr></table>			Size Φ (mm)	Acceptable Qty			A	B	C	$\Phi \leq 0.1$	Ignore		Ignore	$0.1 < \Phi \leq 0.2$	2		$0.2 < \Phi \leq 0.3$	1		$0.3 < \Phi$	0		
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		Assembly deflection	beyond the edge of backlight $\leq 0.15\text{mm}$																							

5.0	TP Related	Newton Ring	Newton area>1/3 NG Newton area≤1/3 OK	TP TP	Ring area Ring area	 1 规律性  2 非规律性  似牛顿环				
		TP corner broken X : length Y : width Z : height	<table><tr><td>X</td><td>Y</td></tr><tr><td>X≤3.0mm</td><td>Y≤3.0mm</td></tr></table> * Circuitry broken is not allowed.	X	Y	X≤3.0mm	Y≤3.0mm			
X	Y									
X≤3.0mm	Y≤3.0mm									
		TP edge broken X : length Y : width Z : height	<table><tr><td>X</td><td>Y</td></tr><tr><td>X≤6.0mm</td><td>Y≤2.0mm</td></tr></table> * Circuitry broken is not allowed.	X	Y	X≤6.0mm	Y≤2.0mm			
X	Y									
X≤6.0mm	Y≤2.0mm									

Number	Items	Criteria (mm)
1	No display	Not allowed
2	Missing segment	Not allowed
3	Short	Not allowed
4	Backlight no lighting	Not allowed
5	TP no function	Not allowed

8. Reliability Test Result

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8.1 Condition

Item	Condition	Sample Size	Test Result	Note
Low Temperature Operating Life test	-20℃, 96HR	3ea	pass	-
Thermal Humidity Operating Life test	60℃, 90%RH, 96HR	3ea	pass	-
Temperature Cycle ON/OFF test	-20℃ ↔ 70℃, ON/OFF, 20CYC	3ea	pass	(1)
High Temperature Storage test	80℃, 96HR	3ea	pass	-
Low Temperature Storage test	- 30℃, 96HR	3ea	pass	-
ESD test	150pF, 330Ω, ±6KV(Contact)/± 8KV(Air), 5 points/panel, 10 times/point	3ea	pass	
Thermal Shock Resistance	The sample should be allowed to stand the following 5 cycles of operation: TSTL for 30 minutes -> normal temperature for 5 minutes -> TSTH for 30 minutes -> normal temperature for 5 minutes, as one cycle, then taking it out and drying it at normal temperature, and allowing it stand for 24 hours	3ea	pass	
Box Drop Test	1 Corner 3 Edges 6 faces, 66cm(MEDIUM BOX)	1box	pass	-

Note (1) ON Time over 10 seconds, OFF Time under 10 seconds

9. Cautions and Handling Precautions

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9.1 Handling and Operating the Module

(1) When the module is assembled, it should be attached to the system firmly.

Do not warp or twist the module during assembly work.

(2) Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.

(3) Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.

(4) Do not allow drops of water or chemicals to remain on the display surface.

If you have the droplets for a long time, staining and discoloration may occur.

(5) If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.

(6) The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane.

Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.

(7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.

(8) Protect the module from static; it may cause damage to the CMOS ICs.

(9) Use finger-stalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.

(10) Do not disassemble the module.

(11) Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.

(12) Pins of I/F connector shall not be touched directly with bare hands.

(13) Do not connect, disconnect the module in the "Power ON" condition.

(14) Power supply should always be turned on/off by the item 6.1 Power On Sequence & 6.2 Power Off Sequence

9.2 Storage and Transportation.

(1) Do not leave the panel in high temperature, and high humidity for a long time.

It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%

(2) Do not store the TFT-LCD module in direct sunlight.

(3) The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.

(4) It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module.

In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.

(5) This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.

10. Packing

-----TBD-----

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